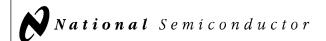
OP-07

OP-07 Low Offset, Low Drift Operational Amplifier



Literature Number: SNOS556A



OP-07 Low Offset, Low Drift Operational Amplifier

General Description

The OP-07 has very low input offset voltage which is obtained by trimming at the wafer stage. These low offset voltages generally eliminate any need for external nulling. The OP-07 also features low input bias current and high openloop gain. The low offsets and high open-loop gain make the OP-07 particularly useful for high-gain applications.

The wide input voltage range of $\pm 13V$ minimum combined with high CMRR of 110 dB and high input impedance provide high accuracy in the non-inverting circuit configuration. Excellent linearity and gain accuracy can be maintained even at high closed-loop gains.

Stability of offsets and gain with time or variation in temperature is excellent.

The OP-07 is available in TO-99 metal can, ceramic or molded DIP. $\,$

For improved specifications, see the LM607.

Features

■ Low V_{OS} 75 μV Max

■ Low V_{OS} Drift 0.6 $\mu V/^{\circ}C$ Max

■ Ultra-Stable vs Time 1.0 µV/Month Max

■ Low Noise 0.6 µVp-p Max
■ Wide Input Voltage Range ± 14V

■ Wide Supply Voltage Range ±3V to ±18V

■ Fits 725/108A/308A, 741, AD510 Sockets

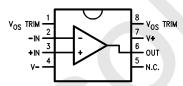
■ Replaces the µA714

Applications

- Strain Gauge Amplifiers
- Thermocouple Amplifiers
- Precision Reference Buffer
- Analog Computing Functions

Connection Diagram

Dual-In-Line Package



TL/H/10550-1

See NS Package Number N08E

Ordering Information

$T_A = 25^{\circ}C$ $V_{OS}Max$ (μV)	N08E Plastic	Operating Temperature Range		
75	OP07EP	СОМ		
150	OP07CP	СОМ		
150	OP07DP	СОМ		

^{*}Also available per SMD #8203602

Absolute Maximum Ratings

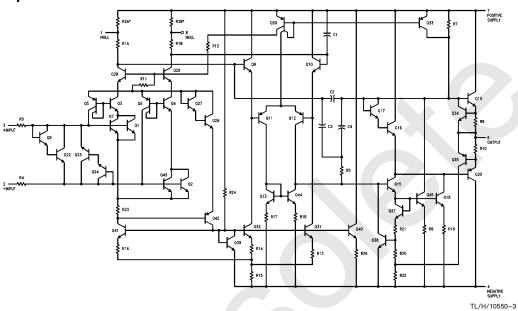
If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

 $\begin{array}{lll} \mbox{Storage Temperature Range} & -65^{\circ}\mbox{C to} + 150^{\circ}\mbox{C} \\ \mbox{Lead Temperature (Soldering, 60 sec.)} & 260^{\circ}\mbox{C} \\ \mbox{Junction Temperature} & -65^{\circ}\mbox{C to} + 150^{\circ}\mbox{C} \\ \end{array}$

Operating Temperature Range

OP-07E, OP-07C, OP-07D 0°C to +70°C

Simplified Schematic



*R2A and R2B are electronically trimmed on chip at the factory for minimum offset voltage.

Electrical Characteristics Unless otherwise specified, $V_S=\pm 15V$, $T_A=25^{\circ}C$. **Boldface** type refers to limits over $0^{\circ}C \leq T_A \leq 70^{\circ}C$

Symbol	Parameter	Conditions	OP-07E			OP-07C			Units
3,			Min	Тур	Max	Min	Тур	Max	00
V _{OS}	Input Offset Voltage	(Note 1)		30 45	75 130		60 85	150 250	μV
V _{OS/t}	Long-Term V _{OS} Stability	(Note 2)		0.3	1.5		0.4	2.0	μV/Mo
los	Input Offset Current			0.5 0.9	3.8 5.3		0.8 1.6	6.0 8.0	nA
I _B	Input Bias Current			±1.2 ± 1.5	± 4.0 ± 5.5		± 1.8 ± 2.2	±7.0 ± 9.0	nA
e _{np-p}	Input Noise Voltage	0.1 Hz to 10 Hz (Note 3)		0.35	0.6		0.38	0.65	μV _{p-p}
e _n	Input Noise Voltage Density	f _O = 10 Hz f _O = 100 Hz (Note 3) f _O = 1000 Hz		10.3 10.0 9.6	18.0 13.0 11.0		10.5 10.2 9.8	20.0 13.5 11.5	nV/√Hz
i _{np-p}	Input Noise Current	0.1 Hz to 10 Hz (Note 3)		14	30		15	35	pA _{p-p}
i _n	Input Noise Current Density	$f_O = 10 \text{ Hz}$ $f_O = 100 \text{ Hz} \text{ (Note 3)}$ $f_O = 1000 \text{ Hz}$		0.32 0.14 0.12	0.80 0.23 0.17		0.35 0.15 0.13	0.90 0.27 0.18	pA/√Hz
R _{IN}	Input Resistance Differential-Mode	(Note 4)	15	50		8	33		МΩ
R _{INCM}	Input Resistance Common-Mode			160			120		GΩ
IVR	Input Voltage Range		± 13.0	± 14.0		± 13	±14		V
CMRR	Common-Mode Rejection Ratio	$V_{CM} = \pm 13V$	106 103	123 123		100 97	120 120		dB
PSRR	Power Supply Rejection Ratio	$V_S = \pm 3V \text{ to } \pm 18V$ $V_S = \pm 3V \text{ to } \pm 18V$		5 7	20 32		7 10	32 51	μV/V
A _{VO}	Large Signal Voltage Gain	$\begin{aligned} R_L &\geq 2 k\Omega, V_O = \pm 10V \\ R_L &\geq 2 k\Omega \\ R_L &\geq 500\Omega, V_O = \pm 0.5V, \\ V_S &= \pm 3V (\text{Note 4}) \end{aligned}$	200 180 150	500 450 400		120 100 100	400 400 400		V/mV
Vo	Output Voltage Swing	$\begin{aligned} &R_{L} \geq 10 k\Omega \\ &R_{L} \geq 2 k\Omega \\ &R_{L} \geq 2 k\Omega \\ &R_{L} \geq 1 k\Omega \end{aligned}$	±12.5 ±12.0 ±12.0 ±10.5	±13.0 ±12.8 ± 12.6 ±12.0		±12.0 ±11.5 ±11.0	±13.0 ±12.8 ± 12.6 ±12.0		V
SR	Slew Rate	$R_L \ge 2 k\Omega$ (Note 3)	0.1	0.3		0.1	0.3		V/μs
BW	Closed-Loop Bandwidth	A _{VCL} = +1 (Note 3)	0.4	0.6		0.4	0.6		MHz
Ro	Output Resistance	$V_0 = 0, I_0 = 0$		60			60		Ω
P _d	Power Consumption	$V_S = \pm 15V$, No Load $V_S = \pm 3V$, No Load		75 4	120 6		80 4	150 8	mW
	Offset Adj. Range	$R_P = 20 \text{ k}\Omega$		±4			±4		mV
TCV _{OS}	Average Input Offset Voltage Drift Without External Trim	(Note 4)		0.3	1.3		0.5	1.8	μV/°C
TCV _{OS} n	With External Trim	$R_P = 20 \text{ k}\Omega \text{ (Note 4)}$		0.3	1.3		0.4	1.6	
TCI _{OS}	Average Input Offset Current Drift	(Note 3)		8	35		12	50	pA/°C
TCIB	Average Input Bias Current Drift	(Note 3)		13	35		18	50	pA/°C

Electrical Characteristics

Unless otherwise specified, $V_S=\pm 15V,\, T_A=25^{\circ}C.$ Boldface type refers to limits over $0^{\circ}C\leq T_A\leq +70^{\circ}C$

Cumbal	Davamatav	Conditions		l lmits			
Symbol	Parameter	Conditions	Min	Тур	Max	Units	
V _{OS}	Input Offset Voltage	(Note 1)		60 85	150 250	μV	
V _{OS/t}	Long-Term V _{OS} Stability	(Note 2)		0.5	3.0	μV/Mo	
los	Input Offset Current			0.8 1.6	6.0 8.0	nA	
I _B	Input Bias Current			±2.0 ± 3.0	±12.0 ± 14.0	nA	
e _{np-p}	Input Noise Voltage	0.1 Hz to 10 Hz (Note 3)		0.38	0.65	μVp-p	
e _n	Input Noise Voltage Density	$f_{O} = 10 \text{ Hz}$ $f_{O} = 100 \text{ Hz} \text{ (Note 3)}$ $f_{O} = 1000 \text{ Hz}$		10.5 10.3 9.8	20.0 13.5 11.5	nV/√Hz	
i _{np-p}	Input Noise Current	0.1 Hz to 10 Hz (Note 3)		15	35	pAp-p	
i _n	Input Noise Current Density	$f_{O} = 10 \text{ Hz}$ $f_{O} = 100 \text{ Hz} \text{ (Note 3)}$ $f_{O} = 1000 \text{ Hz}$		0.35 0.15 0.13	0.90 0.27 0.18	pA/√ Hz	
R _{IN}	Input Resistance Differential-Mode	(Note 4)	7	31	5	МΩ	
R _{INCM}	Input Resistance Common-Mode			120		GΩ	
IVR	Input Voltage Range		± 13	±14		V	
CMRR	Common-Mode Rejection Ratio	$V_{CM} = \pm 13V$	94 94	110 106		dB	
PSRR	Power Supply Rejection Ratio	$V_S = \pm 3V \text{ to } \pm 18V$		7 10	32 5 1	μV/V	
A _{VO}	Large Signal Voltage Gain	$\begin{array}{l} R_L \leq 2 k \Omega, V_O = \pm 10 V \\ R_L = 2 k \Omega, V_O = \pm 10 V \\ R_L \geq 500 \Omega, V_O = \pm 0.5 V, \\ V_S \pm 3 V (\text{Note 4}) \end{array}$	120 100	400 400 400		V/mV	
Vo	Output Voltage Swing	$\begin{aligned} R_L &\geq 10 \text{ k}\Omega \\ R_L &\geq 2 \text{ k}\Omega \\ R_L &\geq 2 \text{ k}\Omega \\ R_L &\geq 1 \text{ k}\Omega \end{aligned}$	±12.0 ±11.5 ± 11.0	±13.0 ±12.8 ± 12.6 ±12.0		V	
SR	Slew Rate	$R_L \ge 2 k\Omega$ (Note 3)	0.1	0.3		V/μs	
BW	Closed-Loop Bandwidth	A _{VCL} = +1 (Note 3)	0.4	0.6		MHz	
RO	Output Resistance	$V_0 = 0, I_0 = 0$		60		Ω	
P _d	Power Consumption	$V_S = \pm 15V$, No Load $V_S = \pm 3V$, No Load		80 4	150 8	mW	
	Offset Adj. Range	$R_P = 20 \text{ k}\Omega$		±4		mV	
TCV _{OS}	Average Input Offset Voltage Drift Without External Trim	(Note 4)		0.7	2.5	μV/°C	
TCV _{OS} n	With External Trim	$R_P = 20 \text{ k}\Omega \text{ (Note 4)}$		0.7	2.5	μV/°C	
TCI _{OS}	Average Input Offset Current Drift	(Note 3)		12	50	pA/°C	
TCIB	Average Input Bias Current Drift	(Note 3)		18	50	pA/°C	

Note 1: $V_{\mbox{OS}}$ is measured approximately 0.5 second after application of power.

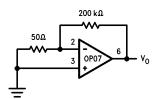
Note 2: Long-Term Offset Voltage Stability refers to the averaged trend line of V_{OS} vs Time over extended periods after the first 30 days of operation. Excluding the initial hour of operation, changes in V_{OS} during the first 30 operating days are typically 2.5 μ V. Parameter is sample tested.

Note 3: Sample Tested.

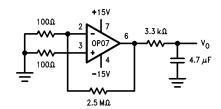
Note 4: Guaranteed by design.

Test Circuits

Offset Voltage Test Circuit



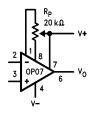
Low Frequency Noise Test Circuit



TL/H/10550-4

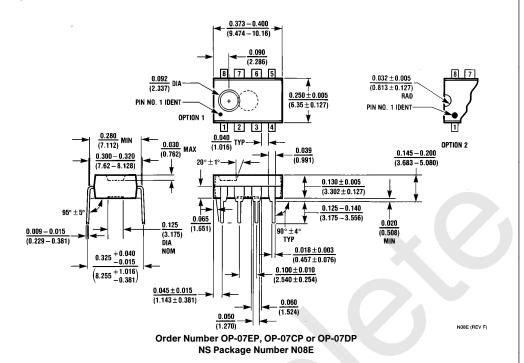
TL/H/10550-5

Optional Offset Nulling Circuit



TL/H/10550-6

Physical Dimensions inches (millimeters) (Continued)



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